5-147291-5 - ACTIVE

AMPMODU | AMPMODU Headers

TE Internal #: 5-147291-5 PCB Mount Header, Vertical, Board-to-Board, 3 Position, 2.54 mm [. 1 in] Centerline, Breakaway, Tin, Surface Mount, Signal, Black, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: **3**

Number of Rows: 1

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Header

Board-to-Board

Breakaway

Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Connector Contact Load Condition	Fully Loaded	
PCB Mount Orientation	Vertical	
Number of Positions	3	
Number of Rows	1	
Board-to-Board Configuration	Parallel	
Body Features		
Primary Product Color	Black	
Contact Features		
Mating Square Post Dimension	.64 mm[.025 in]	
	100 – 200 µin	
PCB Contact Termination Area Plating Material Finish	Matte	
Contact Shape & Form	Square	

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Contact Mating Area Plating Material Finish	Matte	
Contact Underplating Material	Nickel	
PCB Contact Termination Area Plating Material	Tin-Lead	
Contact Base Material	Copper Alloy	
Contact Mating Area Plating Material	Tin	
Contact Mating Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]	
Contact Type	Pin	
Contact Current Rating (Max)	3 A	
Termination Features		
Square Termination Post & Tail Dimension	.64 mm[.025 in]	
	.05 in	
Termination Method to Printed Circuit Board	Surface Mount	
Mechanical Attachment		
Mating Alignment	Without	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Centerline (Pitch)	2.54 mm[.1 in]	
Housing Material	LCP (Liquid Crystal Polymer), LCP-GF (Liquid Crystal Polymer)	
Dimensions		
PCB Thickness (Recommended)	1.6 mm[.063 in]	
Usage Conditions		
Housing Temperature Rating	Standard	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]	
Operation/Application		
Assembly Process Feature	Pick and Place Cap	
	Signal	
Circuit Application	\sim	
Circuit Application Industry Standards		
Circuit Application Industry Standards Approved Standards	CSA LR7189, UL E28476	

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Packaging Features

Packaging Quantity	250
Packaging Type	Tape & Reel

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC	
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.	
Solder Process Capability	Reflow solder capable to 260°C	

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



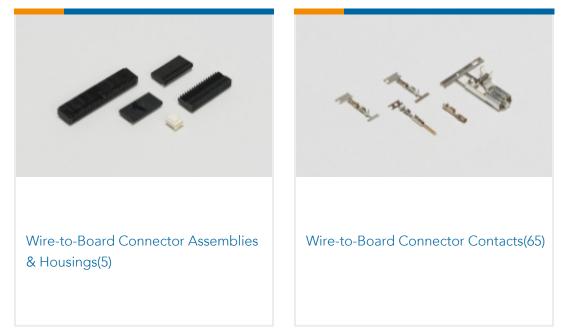
Also in the Series AMPMODU Headers

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Customers Also Bought



MSB0.80RC-ASY040FL,-,30,-TY	QSFP28, 1X3 CAGE ASSEMBLY, SPRING	MJ,ASSY,4P,8POS,CAT5,PNL TABS,.1S /T	MSB0.80PL30ASY040FL,-,30,-TY
The second se			
TE Part #2344054-2 PCIe Gen3.0 SMT type connector 30u" Au	TE Part #5-6450160-4 MBXL R/A RCPT 1P+16S+1P	TE Part #1-1367646-0 Heatsink clip Stamped and Form	TE Part #2024324-1 POWER CABLE ASSY CISCO CGR- 2010

TE Part #5-6450860-5 MBXLE VERT RCPT 1P+16S+1P

Documents

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Product Drawings 03 MODII HDR SR SFMT B/A T&R, lead-Free

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5-147291-5_L.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5-147291-5_L.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5-147291-5_L.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Environmental Compliance MD_5-147291-5_020620192356_dmtec

English

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